FAIRCHILD

SEMICONDUCTOR

FDD8444

N-Channel PowerTrench[®] MOSFET

40V, 50A, 5.2mΩ

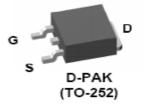
Features

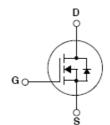
- Typ $r_{DS(on)}$ = 4m Ω at V_{GS} = 10V, I_D = 50A
- Typ $Q_{g(10)}$ = 89nC at V_{GS} = 10V
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse/ Repetitive Pulse)
- Qualified to AEC Q101
- RoHS Compliant



Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Transmission
- Distributed Power Architecture and VRMs
- Primary Switch for 12V Systems





November 2006

MOSFET Maximum Ratings T _C = 25°C unless otherwise noted				
Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain to Source Voltage	40	V	
V _{GS}	Gate to Source Voltage	±20	V	
	Drain Current Continuous (V _{GS} = 10V) (Note 1)	145		
I _D	Continuous (V _{GS} = 10V, with $R_{\theta JA}$ = 52°C/W)	20	Α	
	Pulsed	Figure 4		
E _{AS}	Single Pulse Avalanche Energy (Note 2)	535	mJ	
	Power Dissipation	153	W	
P _D	Derate above 25°C	1.02	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature	-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.98	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient TO-252, 1in ² copper pad area	52	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8444	FDD8444	TO-252AA	13"	12mm	2500 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbo	Parameter	Test Conditions	Min	Тур	Max	Units

Off Characteristics

B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} =	= 0V	40	-	-	V
	Zero Gate Voltage Drain Current	V _{DS} = 32V		-	-	1	
DSS	Zero Gale Vollage Drain Current	$V_{GS} = 0V$	T _J = 150 ^o C	-	-	250	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V		-	-	±100	nA

On Characteristics

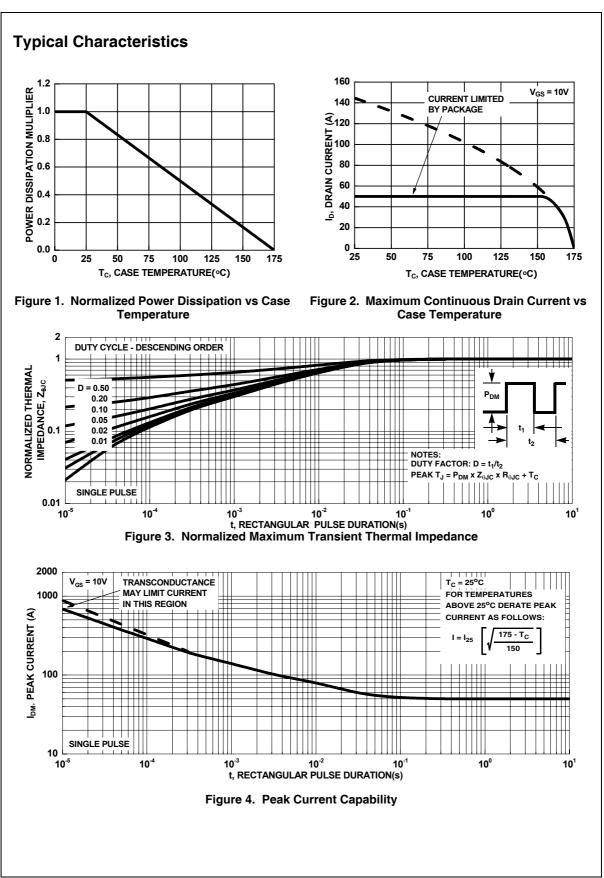
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.5	4	V
		I _D = 50A, V _{GS} = 10V	-	4	5.2	
r _{DS(on)}	Drain to Source On Resistance	$I_D = 50A, V_{GS} = 10V,$ $T_J = 175^{o}C$	-	7.2	9.4	mΩ

Dynamic Characteristics

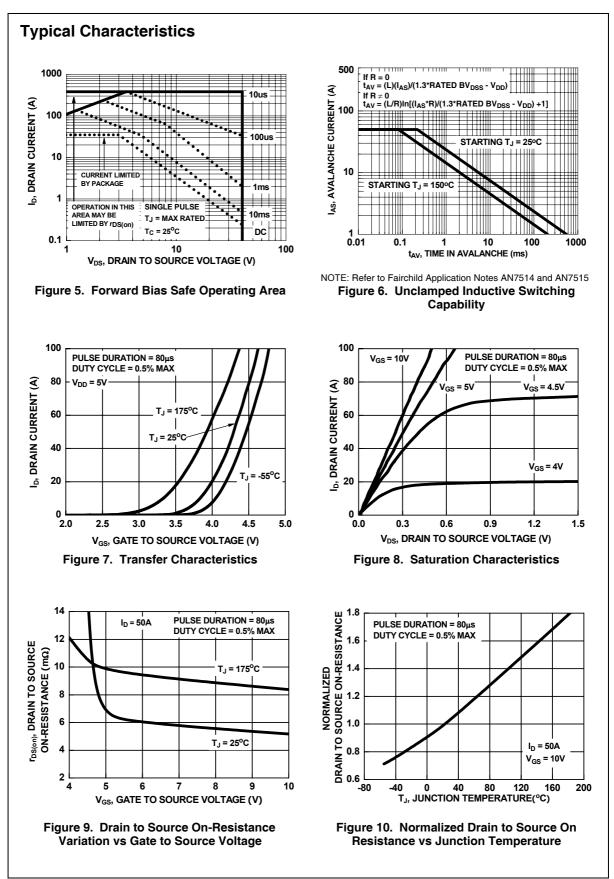
C _{iss}	Input Capacitance		0) (-	6195	-	pF
C _{oss}	Output Capacitance	− V _{DS} = 25V, V _{GS} = (_ f = 1MHz	υν,	-	585	-	pF
C _{rss}	Reverse Transfer Capacitance	1 111112		-	332	-	pF
R _G	Gate Resistance	f = 1MHz		-	1.9	-	Ω
Q _{g(TOT)}	Total Gate Charge at 10V	V_{GS} = 0 to 10V		-	89	116	nC
Q _{g(5)}	Total Gate Charge at 5V	V_{GS} = 0 to 5V			43	56	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} = 20V I _D = 50A	-	11	14.3	nC
Q _{gs}	Gate to Source Gate Charge		$I_{0} = 1.0 \text{mA}$	-	23	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau		.y	-	11	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	20	-	nC

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
witch	ing Characteristics					
n	Turn-On Time		-	-	135	ns
(on)	Turn-On Delay Time	$V_{DD} = 20V, I_D = 50A$ $V_{GS} = 10V, R_{GS} = 2\Omega$	-	12	-	ns
	Turn-On Rise Time		-	78	-	ns
(off)	Turn-Off Delay Time		-	48	-	ns
	Turn-Off Fall Time		-	15	-	ns
f	Turn-Off Time		-	-	95	ns
	Source Diode Characteristics	I _{SD} = 50A I _{SD} = 25A	-	0.9 0.8	1.25 1.0	V
rain-So		I _{SD} = 50A	-			V ns

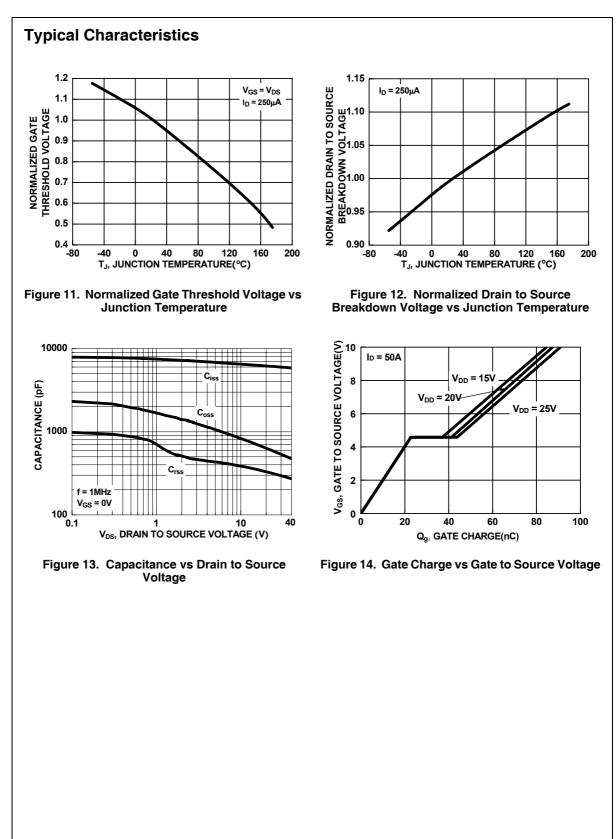
This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/ All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.



FDD8444 N-Channel PowerTrench[®] MOSFET



FDD8444 Rev B (W)



FDD8444 N-Channel PowerTrench[®] MOSFET

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